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at least one lift pin removably coupled with the lift base, the lift pin having two ends with a first end removably coupled to the lift base and a second end for supporting the semiconductor wafer during lifting operation of the lift structure, wherein the first end of the lift pin is threaded and the lift base has a threaded hole for receiving the first end of the lift pin.

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19. (New) The chuck system as claimed in claim 1, further comprising a driving mechanism for driving the lift structure, wherein the lift base of the lift structure includes at least one mounting hole for mounting the lift structure to the driving mechanism, and wherein the mounting hole is positioned closer to the center of the lift base than the lift pin.

**REMARKS**

In the present amendment, Applicant has canceled claims 2 and 10-16, without prejudice or disclaimer of the subject matter thereof. Applicant has also amended claim 1 to more appropriately define the invention, and added new claim 19 to claim additional aspects of the invention. A marked-up version of amended claim 1 is set forth in the Appendix. This amendment is fully supported by the specification and drawings of the originally filed application. See, for example, page 9, lines 1-7, of the specification, and Figs. 5 and 7 of the drawings. Therefore, no new matter has been added by the amendment. Upon the entry of the amendment, claims 1, 3-9, and 17-19 are pending.

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